

CoreFocus Report

No.473

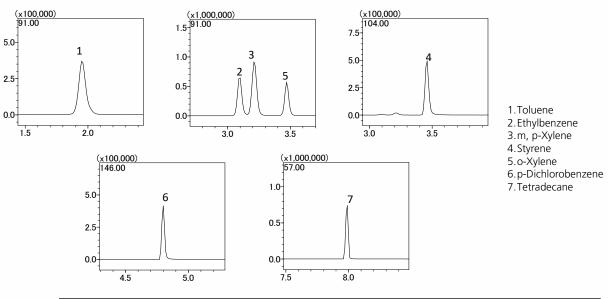
GC-MS

SH Series

SH-I-5Sil MS

Analysis of VOCs

Keywords: Thermal desorption system, Hydrogen carrier gas, Volatile organic compounds



: GCMS-QPTM 2020 NX GC-MS System

Autosampler : TD-30R Column : SH-I-5Sil MS

 $(30 \text{ m} \times 0.25 \text{ mm} \text{ I.D., } 0.25 \text{ } \mu\text{m})$,

P/N: 221-75954-30

[TD-30R]

Tube Desorb Temp. : 280 °C(10 min) : 60 mL/min (N₂) Tube Desorb Flow

Trap Cooling Temp. : -20°C Trap Desorb Temp. : 250°C (10 min)

Joint Temp. : 250°C Valve Temp. 250°C

Transfer Line Temp. : 250°C

Dry Purge : 25°C (20 mL/min, 3 min) [GC]

Injection Method : Split Split Ratio : 20 Carrier Gas : H₂

Carrier Gas Control: Pressure (80.0 kPa)

Column Temperature: 40°C (2 min) -20°C/min -300°C (3 min)

[MS]

Ionsource Temp. : 200°C Interface Temp. : 230°C Ionization Method

Source: Application News 01-00541 (JP, ENG)

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